



AO4427

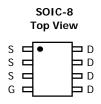
P-Channel Enhancement Mode Field Effect Transistor

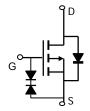
General Description

The AO4427 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected. Standard Product AO4427 is Pb-free (meets ROHS & Sony 259 specifications). AO4427L is a Green Product ordering option. AO4427 and AO4427L are electrically identical

Features

$$\begin{split} &V_{DS} \; (V) = -30V \\ &I_{D} = -12.5 \; A \; (V_{GS} = -20V) \\ &R_{DS(ON)} < 12 m\Omega \; (V_{GS} = -20V) \\ &R_{DS(ON)} < 14 m\Omega \; (V_{GS} = -10V) \\ &ESD \; Rating: \; 2KV \; HBM \end{split}$$





Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	-30	V			
Gate-Source Voltage		V_{GS}	±25	V			
Continuous Drain	T _A =25°C		-12.5				
Current ^A	T _A =70°C	I_{D}	-10.5	A			
Pulsed Drain Current ^B		I _{DM}	-60	1			
	T _A =25°C	D	3	10/			
Power Dissipation A	T _A =70°C	$-P_{D}$	2.1	- W			
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	Ь	28	40	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	$ R_{\theta JA}$	54	75	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	21	30	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V				-1	
			T _J =55°C			-5	μА
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±25V				±1	μА
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$		-1.7	-2.5	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V		-60			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-20V, I _D =-12.5A			9.4	12	$$ m Ω
			T _J =125°C		12.2	15	
		V_{GS} =-10V, I_D =-10A			11.5	14	mΩ
		V_{GS} =-4.5V, I_{D} =-5A		32		mΩ	
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-12.5A			24		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V				-1	V
Is	Maximum Body-Diode Continuous Current					-4.2	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			2330	2900	pF
C _{oss}	Output Capacitance				480		pF
C _{rss}	Reverse Transfer Capacitance				320		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			6.8	10	Ω
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge	-V _{GS} =-10V, V _{DS} =-15V, -I _D =-12.5A			41	52	nC
Q_{gs}	Gate Source Charge				10		nC
Q_{gd}	Gate Drain Charge				12		nC
t _{D(on)}	Turn-On DelayTime				12.8		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.2 Ω , R_{GEN} =3 Ω			10.3		ns
t _{D(off)}	Turn-Off DelayTime				49.5		ns
t _f	Turn-Off Fall Time				29		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-12.5A, dI/dt=100A/μs			28	35	ns
Q _{rr}	Body Diode Reverse Recovery Charge	l _F =-12.5A, dl/dt=100A/μs			20		nC

A: The value of $R_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

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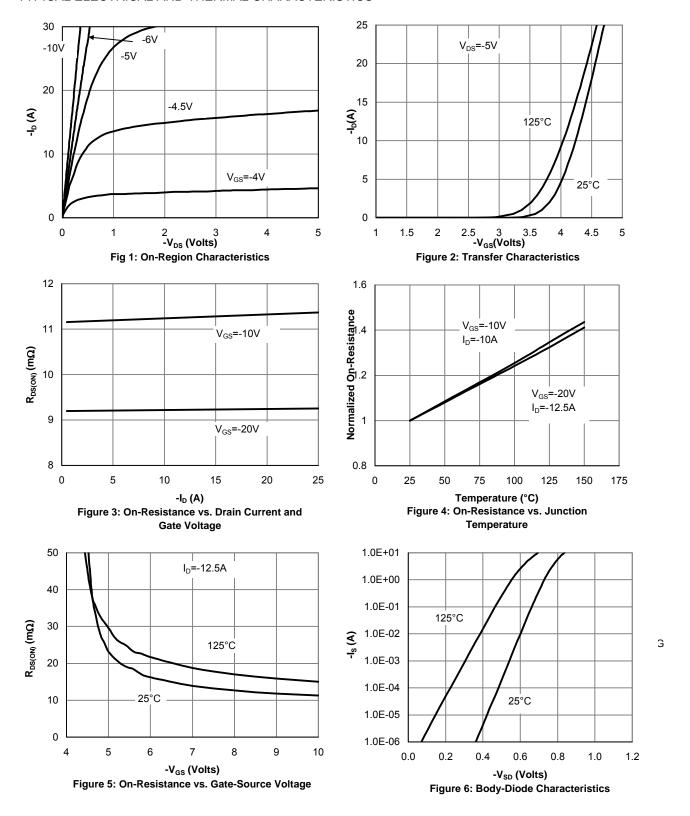
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

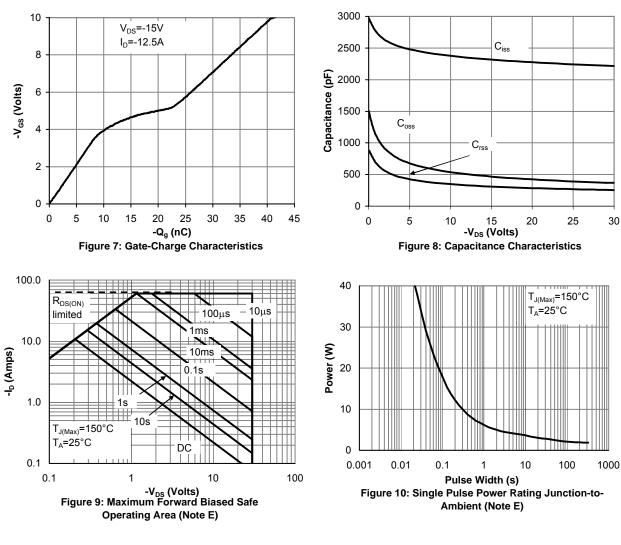
D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.

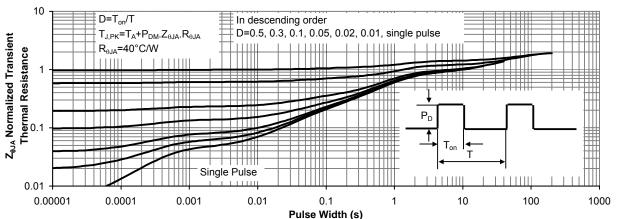
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating. Rev2: August 2005

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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Figure 11: Normalized Maximum Transient Thermal Impedance